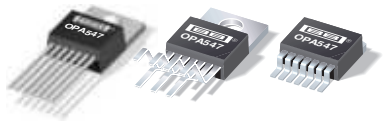
OPA547



SBOS056F – JANUARY 2002 – JULY 2005

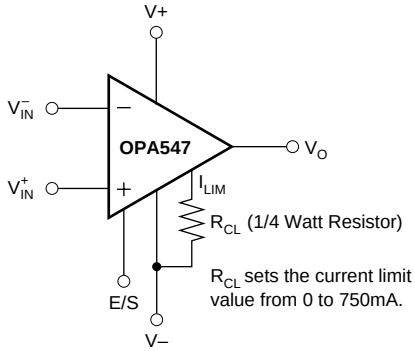
High-Voltage, High-Current OPERATIONAL AMPLIFIER

FEATURES

- **WIDE SUPPLY RANGE**
  Single Supply: +8V to +60V
  Dual Supply: ±4V to ±30V
- **HIGH OUTPUT CURRENT:**
  500mA Continuous
- **WIDE OUTPUT VOLTAGE SWING**
- **FULLY PROTECTED:**
  Thermal Shutdown
  Adjustable Current Limit
- **OUTPUT DISABLE CONTROL**
- **THERMAL SHUTDOWN INDICATOR**
- **HIGH SLEW RATE: 6V/μs**
- **LOW QUIESCENT CURRENT**
- **PACKAGES:**
  7-Lead TO-220, Zip and Straight Leads
  7-Lead DDPAK Surface-Mount

APPLICATIONS

- **VALVE, ACTUATOR DRIVERS**
- **SYNCHRO, SERVO DRIVERS**
- **POWER SUPPLIES**
- **TEST EQUIPMENT**
- **TRANSDUCER EXCITATION**
- **AUDIO AMPLIFIERS**



DESCRIPTION

The OPA547 is a low-cost, high-voltage/high-current operational amplifier ideal for driving a wide variety of loads. A laser-trimmed monolithic integrated circuit provides excellent low-level signal accuracy and high output voltage and current.

The OPA547 operates from either single or dual supplies for design flexibility. In single-supply operation, the input common-mode range extends below ground.

The OPA547 is internally protected against over-temperature conditions and current overloads. In addition, the OPA547 was designed to provide an accurate, user-selected current limit. Unlike other designs which use a “power” resistor in series with the output current path, the OPA547 senses the load indirectly. This allows the current limit to be adjusted from 0mA to 750mA with a 0 to 150μA control signal. This is easily done with a resistor/potentiometer or controlled digitally with a voltage-out or current-out DAC.

The Enable/Status (E/S) pin provides two functions. An input on the pin not only disables the output stage to effectively disconnect the load, but also reduces the quiescent current to conserve power. The E/S pin output can be monitored to determine if the OPA547 is in thermal shutdown.

The OPA547 is available in an industry-standard 7-lead staggered and straight lead TO-220 package, and a 7-lead DDPAK surface-mount plastic power package. The copper tab allows easy mounting to a heat sink or circuit board for excellent thermal performance. It is specified for operation over the extended industrial temperature range, –40°C to +85°C.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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ABSOLUTE MAXIMUM RATINGS(1)

Output Current	See SOA Curve
Supply Voltage, V+ to V–	60V
Input Voltage	(V–) – 0.5V to (V+) + 0.5V
Input Shutdown Voltage	V+
Operating Temperature	–40°C to +125°C
Storage Temperature	–55°C to +125°C
Junction Temperature	150°C
Lead Temperature (soldering 10s)(2)	300°C

NOTES: (1) Stresses above these ratings may cause permanent damage. (2) Vapor-phase or IR reflow techniques are recommended for soldering the OPA547F surface-mount package. Wave soldering is not recommended due to excessive thermal shock and "shadowing" of nearby devices.

ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

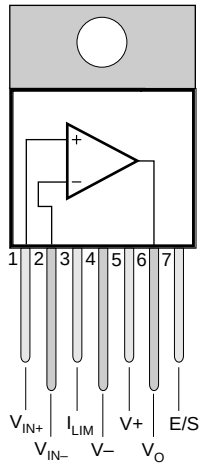
PACKAGE/ORDERING INFORMATION

For the most current package and ordering information, see the Package Ordering Addendum at the end of this document, or see the TI website at www.ti.com.

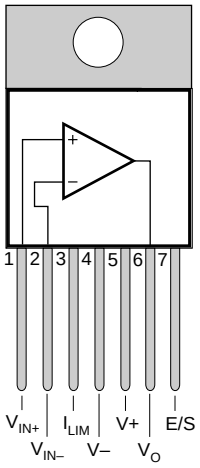
PIN CONFIGURATIONS

Top Front View

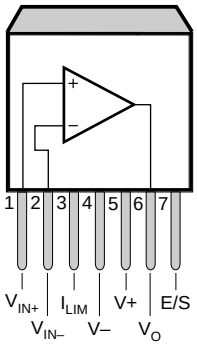
7-Lead Stagger-Formed TO-220 (T)



7-Lead Straight-Formed TO-220 (T-1)



7-Lead DDPAK (FA) Surface-Mount



NOTE: Tabs are electrically connected to the V– supply.

ELECTRICAL CHARACTERISTICS

At T_{CASE} = +25°C, V_S = ±30V and E/S pin open, unless otherwise noted.

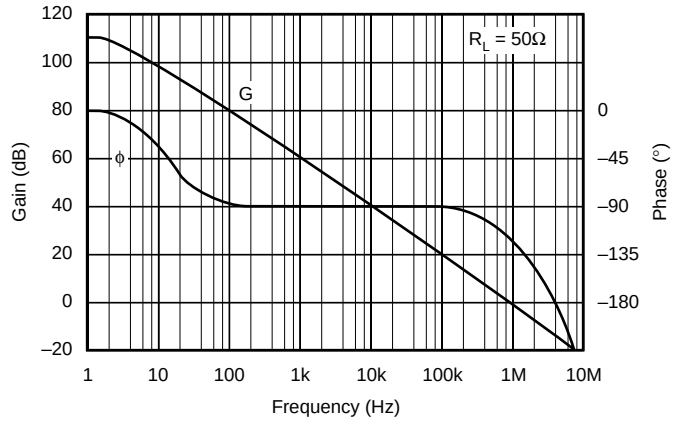
PARAMETER	CONDITION	OPA547T, F MIN	OPA547T, F TYP	OPA547T, F MAX	UNITS
OFFSET VOLTAGE					
Input Offset Voltage	V_{CM} = 0, I_O = 0		±1	±5	mV
vs Temperature	T_A = –40°C to +85°C		±25		µV/°C
vs Power Supply	V_S = ±4V to ±30V		10	100	µV/V
INPUT BIAS CURRENT(1)					
Input Bias Current(2)	V_{CM} = 0V		–100	–500	nA
vs Temperature			±0.5		nA/°C
Input Offset Current	V_{CM} = 0V		±5	±50	nA
NOISE					
Input Voltage Noise Density, f = 1kHz			90		$nV/\sqrt{Hz}$
Current Noise Density, f = 1kHz			200		$fA/\sqrt{Hz}$
INPUT VOLTAGE RANGE					
Common-Mode Voltage Range: Positive	Linear Operation	(V+) –3	(V+) –2.3		V
Negative	Linear Operation	(V–) –0.1	(V–) –0.2		V
Common-Mode Rejection	V_{CM} = (V–) –0.1V to (V+) –3V	80	95		dB
INPUT IMPEDANCE					
Differential			10^7 || 6		Ω || pF
Common-Mode			10^9 || 4		Ω || pF
OPEN-LOOP GAIN					
Open-Loop Voltage Gain, f = 10Hz	V_O = ±25V, R_L = 1kΩ	100	115		dB
	V_O = ±25V, R_L = 50Ω		110		dB
FREQUENCY RESPONSE					
Gain-Bandwidth Product	R_L = 50Ω		1		MHz
Slew Rate	G = 1, $50V_{PP}$, R_L = 50Ω		6		V/µs
Full-Power Bandwidth			See Typical Curve		kHz
Settling Time: ±0.1%	G = –10, 50V Step		18		µs
Total Harmonic Distortion + Noise, f = 1kHz	R_L = 50Ω, G = +3V, 1W Power		0.004(3)		%
OUTPUT					
Voltage Output, Positive	I_O = 0.5A	(V+) –2.2	(V+) –1.9		V
Negative	I_O = –0.5A	(V–) +1.6	(V–) +1.3		V
Positive	I_O = 0.1A	(V+) –1.8	(V+) –1.5		V
Negative	I_O = –0.1A	(V–) +1.2	(V–) +0.8		V
Maximum Continuous Current Output: dc		±500			mA
ac		500			mArms
Leakage Current, Output Disabled, dc			See Typical Curve		
Output Current Limit					
Current Limit Range			0 to ±750		mA
Current Limit Equation			$I_{LIM} = (5000)(4.75)/(31600Ω + R_{CL})$		A
Current Limit Tolerance(1)	R_{CL} = 31.6kΩ (I_{LIM} = ±375mA), R_L = 50Ω		±10	±30	mA
Capacitive Load Drive			See Typical Curve(4)		
OUTPUT ENABLE /STATUS (E/S) PIN					
Shutdown Input Mode					
$V_{E/S}$ HIGH (output enabled)	E/S Pin Open or Forced HIGH	(V–) +2.4			V
$V_{E/S}$ LOW (output disabled)	E/S Pin Forced LOW			(V–) +0.8	V
$I_{E/S}$ HIGH (output enabled)	E/S Pin HIGH		–60		µA
$I_{E/S}$ LOW (output disabled)	E/S Pin LOW		–65		µA
Output Disable Time			1		µs
Output Enable Time			3		µs
Thermal Shutdown Status Output					
Normal Operation	Sourcing 20µA	(V–) +2.4	(V–) +3.5		V
Thermally Shutdown	Sinking 5µA, T_J > 160°C		(V–) +0.35	(V–) +0.8	V
Junction Temperature, Shutdown			+160		°C
Reset from Shutdown			+140		°C
POWER SUPPLY					
Specified Voltage			±30		V
Operating Voltage Range		±4		±30	V
Quiescent Current	I_{LIM} Connected to V–, I_O = 0		±10	±15	mA
Quiescent Current, Shutdown Mode	I_{LIM} Connected to V–		±4		mA
TEMPERATURE RANGE					
Specified Range		–40		+85	°C
Operating Range		–40		+125	°C
Storage Range		–55		+125	°C
Thermal Resistance, θ_{JC}					
7-Lead DDPAK, 7-Lead TO-220	f > 50Hz		2		°C/W
7-Lead DDPAK, 7-Lead TO-220	dc		3		°C/W
Thermal Resistance, θ_{JA}					
7-Lead DDPAK, 7-Lead TO-220	No Heat Sink		65		°C/W

NOTES: (1) High-speed test at T_J = +25°C. (2) Positive conventional current flows into the input terminals. (3) See *Total Harmonic Distortion+Noise* in the Typical Characteristics section for additional power levels. (4) See *Small-Signal Overshoot vs Load Capacitance* in the Typical Characteristics section.

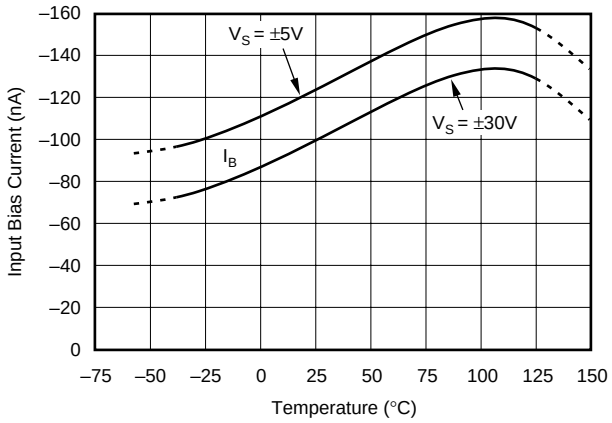
TYPICAL CHARACTERISTICS

At T_{CASE} = +25°C, V_S = ±30V, and E/S pin open, unless otherwise noted.

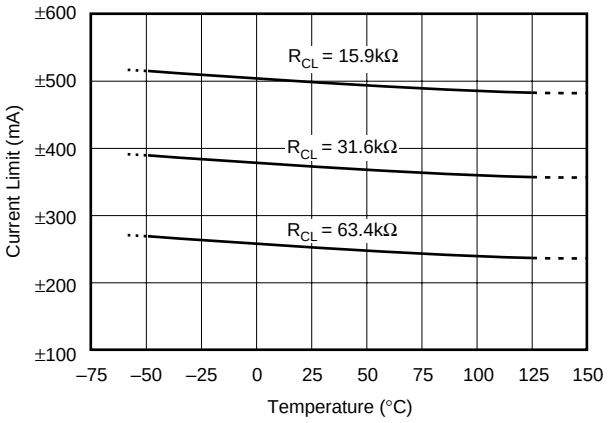
OPEN-LOOP GAIN AND PHASE vs FREQUENCY



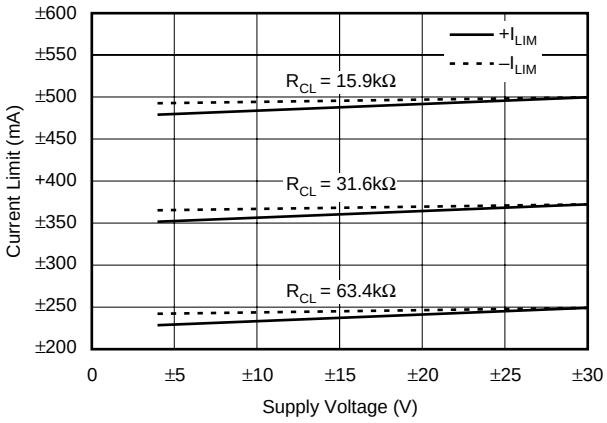
INPUT BIAS CURRENT vs TEMPERATURE



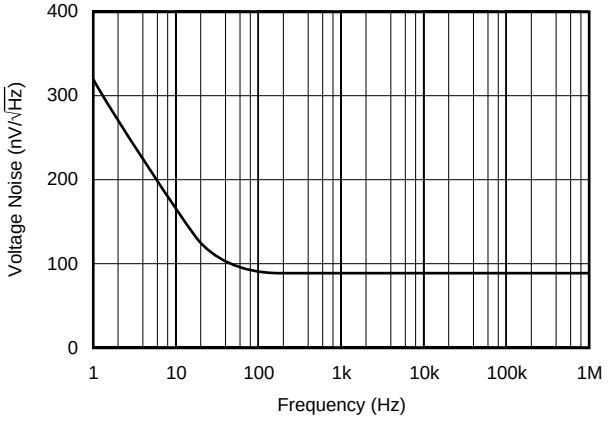
CURRENT LIMIT vs TEMPERATURE



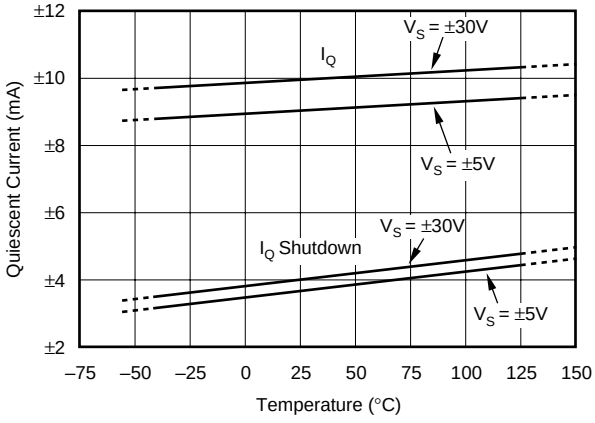
CURRENT LIMIT vs SUPPLY VOLTAGE



VOLTAGE NOISE DENSITY vs FREQUENCY



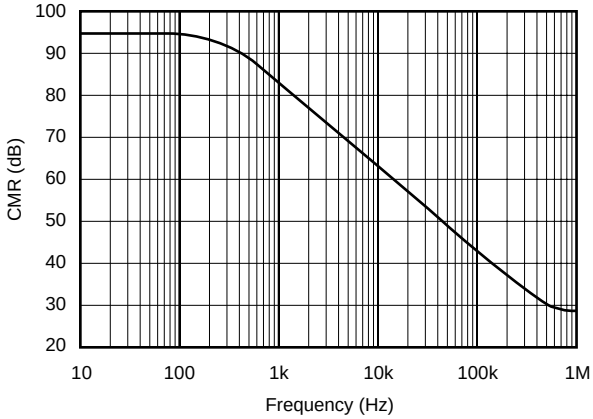
QUIESCENT CURRENT vs TEMPERATURE



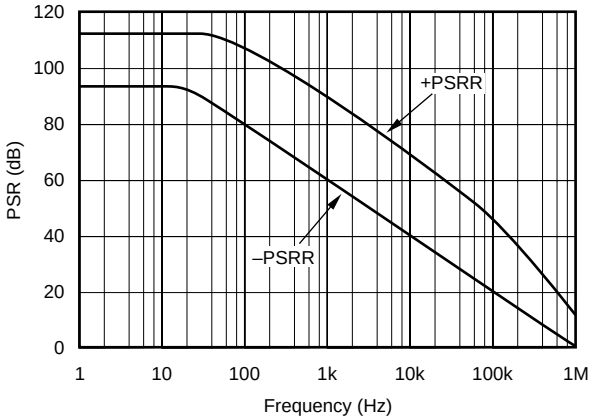
TYPICAL CHARACTERISTICS (Cont.)

At T_{CASE} = +25°C, V_S = ±30V, and E/S pin open, unless otherwise noted.

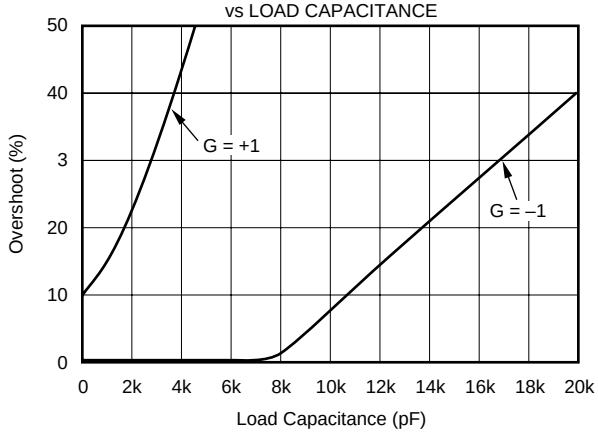
COMMON-MODE REJECTION vs FREQUENCY



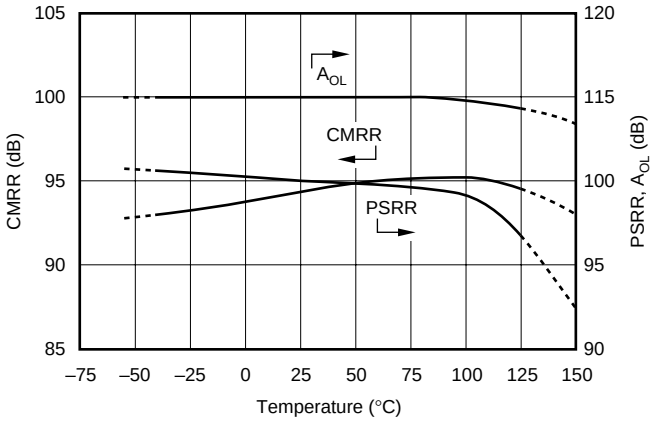
POWER SUPPLY REJECTION vs FREQUENCY



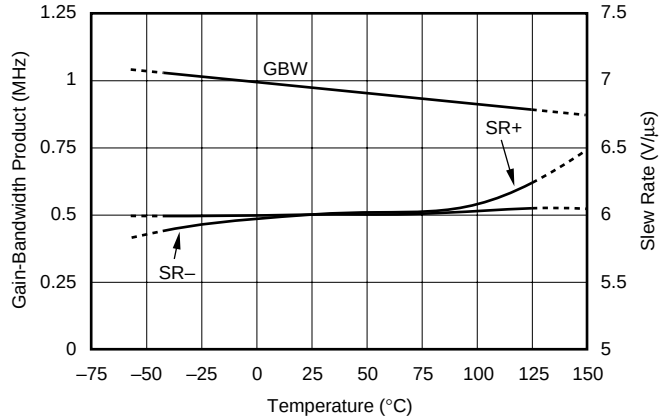
SMALL-SIGNAL OVERSHOOT vs LOAD CAPACITANCE



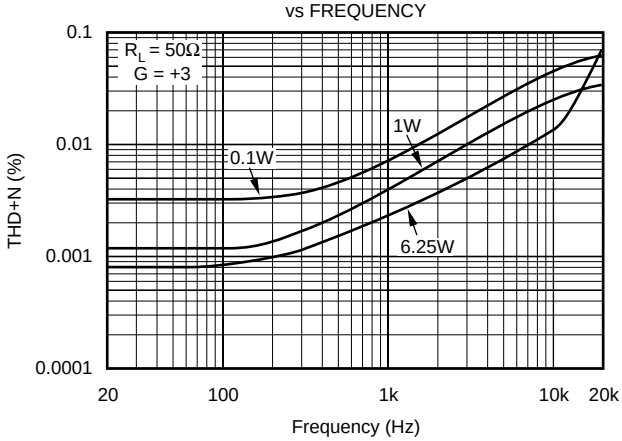
OPEN-LOOP GAIN, COMMON-MODE REJECTION, AND POWER SUPPLY REJECTION vs TEMPERATURE



GAIN-BANDWIDTH PRODUCT AND SLEW RATE vs TEMPERATURE



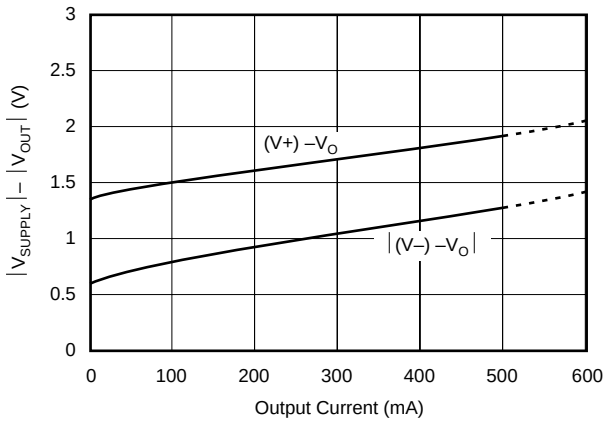
TOTAL HARMONIC DISTORTION+NOISE vs FREQUENCY



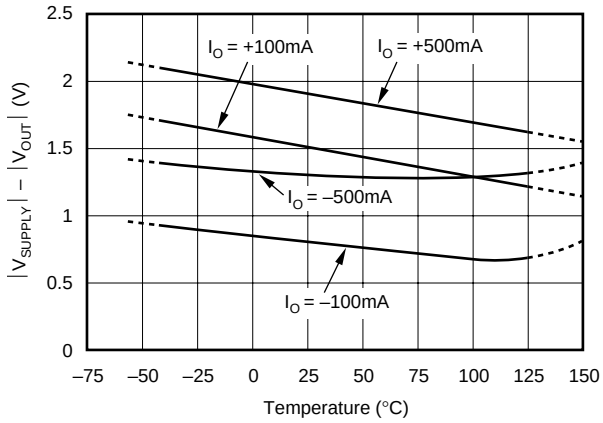
TYPICAL CHARACTERISTICS (Cont.)

At T_{CASE} = +25°C, V_S = ±30V, and E/S pin open, unless otherwise noted.

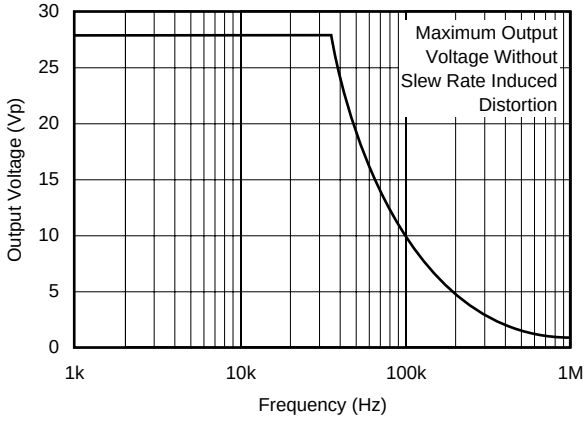
OUTPUT VOLTAGE SWING vs OUTPUT CURRENT



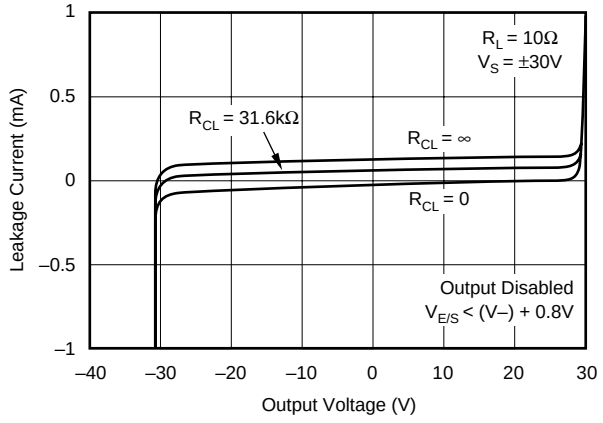
OUTPUT VOLTAGE SWING vs TEMPERATURE



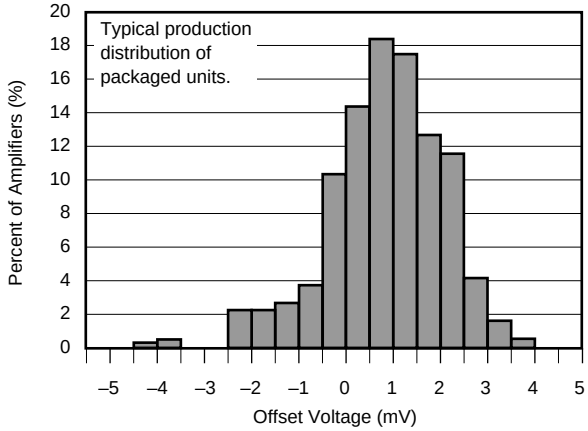
MAXIMUM OUTPUT VOLTAGE SWING vs FREQUENCY



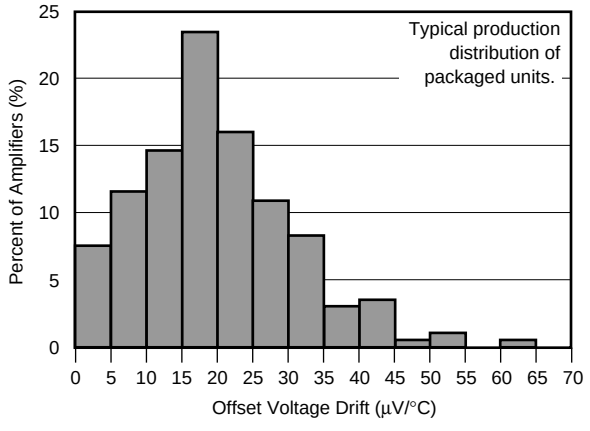
OUTPUT LEAKAGE CURRENT vs APPLIED OUTPUT VOLTAGE



OFFSET VOLTAGE PRODUCTION DISTRIBUTION



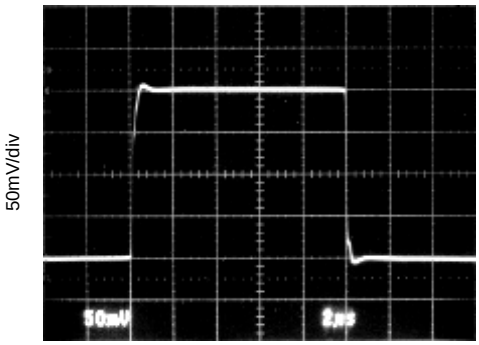
OFFSET VOLTAGE DRIFT PRODUCTION DISTRIBUTION



TYPICAL CHARACTERISTICS (Cont.)

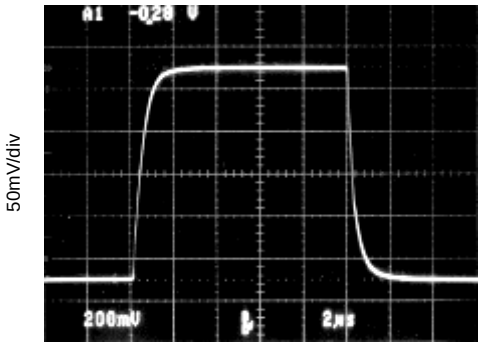
At T_{CASE} = +25°C, V_S = ±35V, and E/S pin open, unless otherwise noted.

SMALL SIGNAL STEP RESPONSE
G = 1, C_L = 1000pF



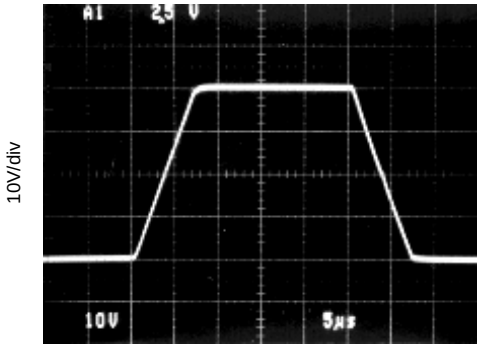
2µs/div

SMALL SIGNAL STEP RESPONSE
G = 3, C_L = 1000pF



2µs/div

LARGE SIGNAL STEP RESPONSE
G = 3, C_L = 100pF, R_L = 50Ω

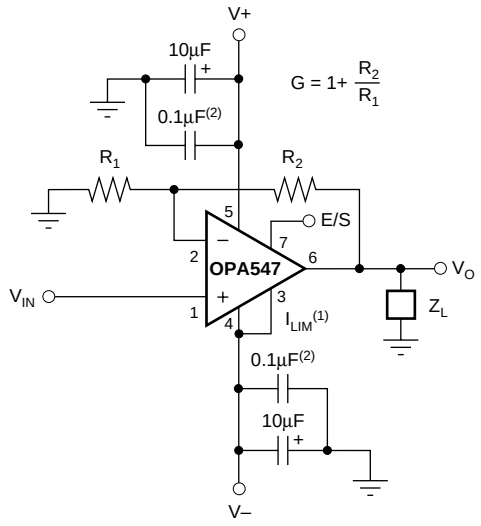


5µs/div

APPLICATIONS INFORMATION

Figure 1 shows the OPA547 connected as a basic noninverting amplifier. The OPA547 can be used in virtually any op amp configuration.

Power-supply terminals should be bypassed with low series impedance capacitors. The technique shown, using a ceramic and tantalum type in parallel, is recommended. Power-supply wiring should have low series impedance.



NOTES: (1) I_{LIM} connected to V– gives the maximum current limit, 750mA (peak). (2) Connect 0.1µF capacitors directly to package power-supply pins.

FIGURE 1. Basic Circuit Connections.

POWER SUPPLIES

The OPA547 operates from single (+8V to +60V) or dual (±4V to ±30V) supplies with excellent performance. Most behavior remains unchanged throughout the full operating voltage range. Parameters which vary significantly with operating voltage are shown in the typical characteristic curves.

Some applications do not require equal positive and negative output voltage swing. Power-supply voltages do not need to be equal. The OPA547 can operate with as little as 8V between the supplies and with up to 60V between the supplies. For example, the positive supply could be set to 55V with the negative supply at –5V, or vice-versa.

ADJUSTABLE CURRENT LIMIT

The OPA547 features an accurate, user-selected current limit. Current limit is set from 0mA to 750mA by controlling the input to the I_{LIM} pin. Unlike other designs which use a power resistor in series with the output current path, the OPA547 senses the load indirectly. This allows the current limit to be set with a 0µA to 150µA control signal. In contrast, other designs require a limiting resistor to handle the full output current (750mA in this case).

With the OPA547, the simplest method for adjusting the current limit uses a resistor or potentiometer connected between the I_{LIM} pin and V– according to the Equation 1:

$$R_{CL} = \frac{(5000)(4.75)}{I_{LIM}} - 31.6k\Omega \quad (1)$$

The low-level control signal (0µA to 150µA) also allows the current limit to be digitally controlled with a current-out or voltage-out DAC reference to V– according to the equations given in Figure 3.

Figure 3 shows a simplified schematic of the internal circuitry used to set the current limit. Leaving the I_{LIM} pin open programs the output current to zero, while connecting I_{LIM} directly to V– programs the maximum output current limit, typically 750mA.

SAFE OPERATING AREA

Stress on the output transistors is determined both by the output current and by the output voltage across the conducting output transistor, $V_S - V_O$. The power dissipated by the output transistor is equal to the product of the output current and the voltage across the conducting transistor, $V_S - V_O$. The Safe Operating Area (SOA curve, Figure 2) shows the permissible range of voltage and current.

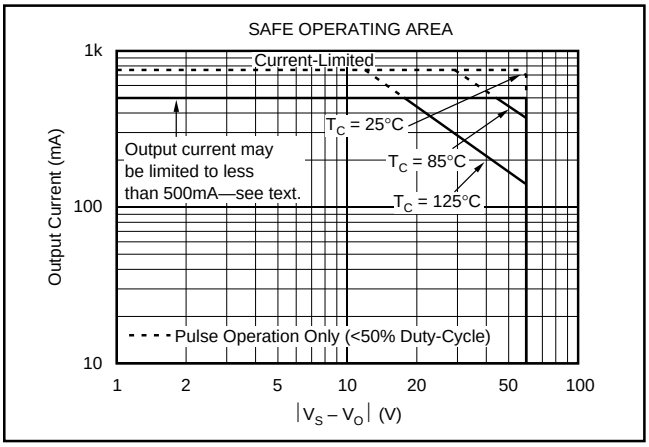


FIGURE 2. Safe Operating Area.

The safe output current decreases as $V_S - V_O$ increases. Output short-circuits are a very demanding case for SOA. A short-circuit to ground forces the full power-supply voltage (V+ or V–) across the conducting transistor. With $T_C = 25°C$ the maximum output current of 500mA can be achieved under most conditions. Increasing the case temperature reduces the safe output current that can be tolerated without activating the thermal shutdown circuit of the OPA547. For further insight on SOA, consult Application Bulletin SBOA022.

POWER DISSIPATION

Power dissipation depends on power supply, signal, and load conditions. For dc signals, power dissipation is equal to the product of output current times the voltage across the con-

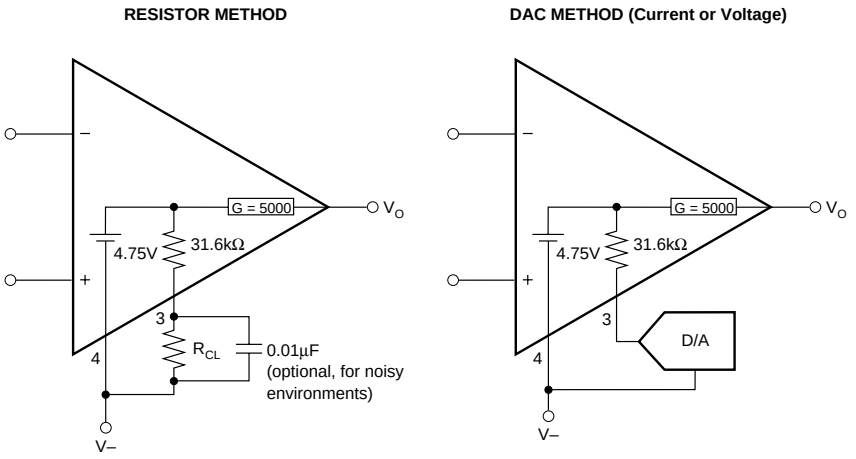
ducting output transistor. Power dissipation can be minimized by using the lowest possible power-supply voltage necessary to assure the required output voltage swing.

For resistive loads, the maximum power dissipation occurs at a dc output voltage of one-half the power-supply voltage. Dissipation with ac signals is lower. Application Bulletin SBOA022 explains how to calculate or measure power dissipation with unusual signals and loads.

HEAT SINKING

Most applications require a heat sink to assure that the maximum junction temperature (150°C) is not exceeded. The heat sink required depends on the power dissipated and on ambient conditions. Consult Application Bulletin SBOA021 for information on determining heat sink requirements. The internal protection circuitry was designed to protect against overload conditions. It does not activate until the junction temperature reaches approximately 160°C and was not intended to replace proper heat sinking. Continuously running the OPA547 into thermal shutdown will degrade reliability.

The tab of the DDPAK surface-mount version should be soldered to a circuit board copper area for good heat dissipation. Figure 4 shows typical thermal resistance from junction to ambient as a function of the copper area.



$$R_{CL} = \frac{5000\ (4.75V)}{I_{LIM}} - 31.6k\Omega$$

$I_{DAC} = I_{LIM}/5000$

$V_{DAC} = (V–) + 4.75V – (31.6k\Omega)\ (I_{LIM})/5000$

OPA547 CURRENT LIMIT: 0mA to 750mA

DESIRED CURRENT LIMIT	RESISTOR(1) (R_{CL})	CURRENT DAC (I_{DAC})	VOLTAGE DAC (V_{DAC})
0mA	I_{LIM} Open	0µA	(V–) + 4.75V
100mA	205kΩ	20µA	(V–) + 4.12V
375mA	31.6kΩ	75µA	(V–) + 2.38V
500mA	15.8kΩ	100µA	(V–) + 1.59V
750mA	I_{LIM} Shorted to V–	150µA	(V–) + 0.01V

NOTE: (1) Resistors are nearest standard 1% values.

FIGURE 3. Adjustable Current Limit.

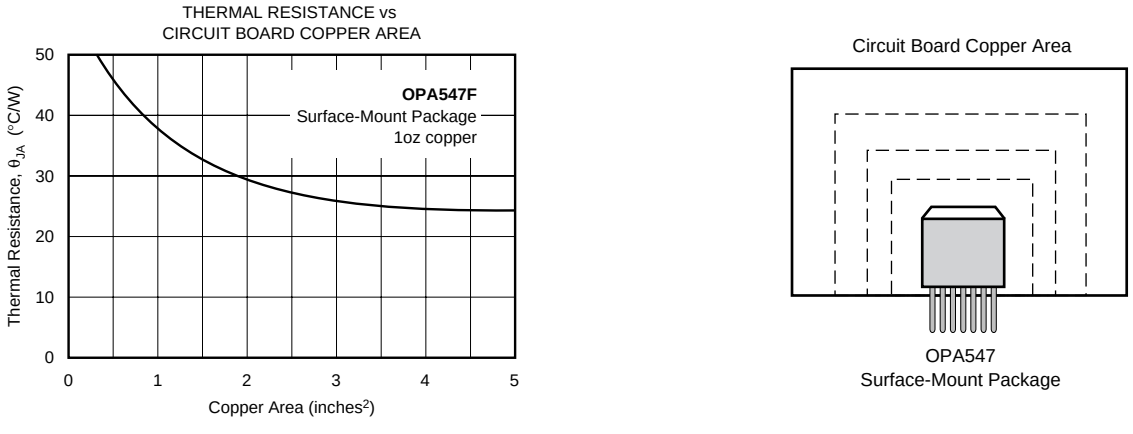


FIGURE 4. Thermal Resistance versus Circuit Board Copper Area.

THERMAL PROTECTION

The OPA547 has thermal shutdown that protects the amplifier from damage. Activation of the thermal shutdown circuit during normal operation is an indication of excessive power dissipation or an inadequate heat sink. Depending on load and signal conditions, the thermal protection circuit may cycle on and off. This limits the dissipation of the amplifier but may have an undesirable effect on the load.

The thermal protection activates at a junction temperature of approximately 160°C. However, for reliable operation, junction temperature should be limited to 150°C. To estimate the margin of safety in a complete design (including heat sink), increase the ambient temperature until the thermal protection is activated. Use worst-case load and signal conditions. For good reliability, the thermal protection should trigger more than 35°C above the maximum expected ambient condition of the application. This produces a junction temperature of 125°C at the maximum expected ambient condition.

ENABLE/STATUS (E/S) PIN

The Enable/Status pin provides two functions: forcing this pin low disables the output stage, or E/S can be monitored to determine if the OPA547 is in thermal shutdown. One or both of these functions can be utilized on the same device using single or dual supplies. For normal operation (output enabled), the E/S pin can be left open or pulled high (at least +2.4V above the negative rail).

Output Disable

A unique feature of the OPA547 is its output disable capability. This function not only conserves power during idle periods (quiescent current drops to approximately 4mA), but also allows multiplexing in low frequency (f<10kHz), multichannel applications. Signals that are greater than 10kHz may cause leakage current to increase in devices that are shutdown. Figure 15 shows the two OPA547s in a switched amplifier configuration. The on/off state of the two amplifiers is controlled by the voltage on the E/S pin.

To disable the output, the E/S pin is pulled low, no greater than 0.8V above the negative rail. Typically the output is shutdown in 1µs. Figure 5 provides an example of how to implement this function using a single supply. Figure 6 gives a circuit for dual-supply applications. To return the output to an enabled state, the E/S pin should be disconnected (open) or pulled to at least (V–) + 2.4V. It should be noted that pulling the E/S pin high (output enabled) does not disable internal thermal shutdown.

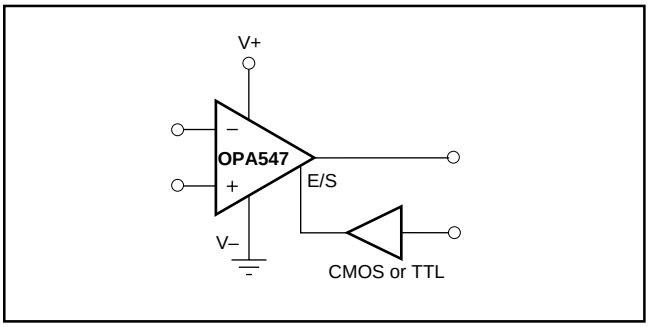


FIGURE 5. Output Disable with a Single Supply.

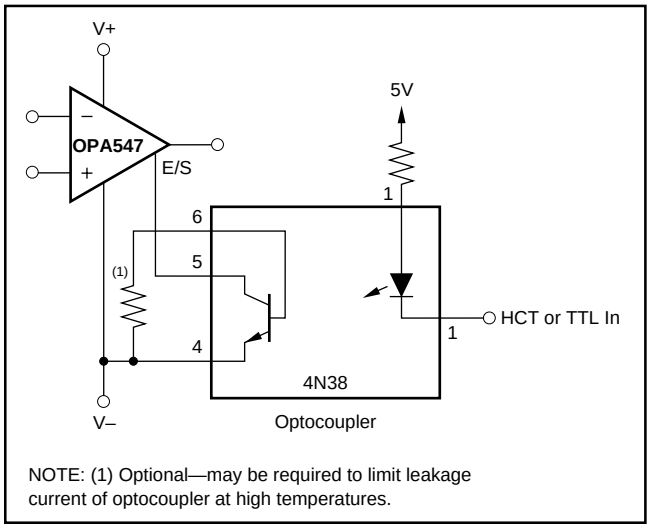


FIGURE 6. Output Disable with Dual Supplies.

Thermal Shutdown Status

Internal thermal shutdown circuitry shuts down the output when the die temperature reaches approximately 160°C, resetting when the die has cooled to 140°C. The E/S pin can be monitored to determine if shutdown has occurred. During normal operation the voltage on the E/S pin is typically 3.5V above the negative rail. Once shutdown has occurred this voltage drops to approximately 350mV above the negative rail.

Figure 7 gives an example of monitoring shutdown in a single-supply application. Figure 8 provides a circuit for dual supplies. External logic circuitry or an LED could be used to indicate if the output has been thermally shutdown, see Figure 13.

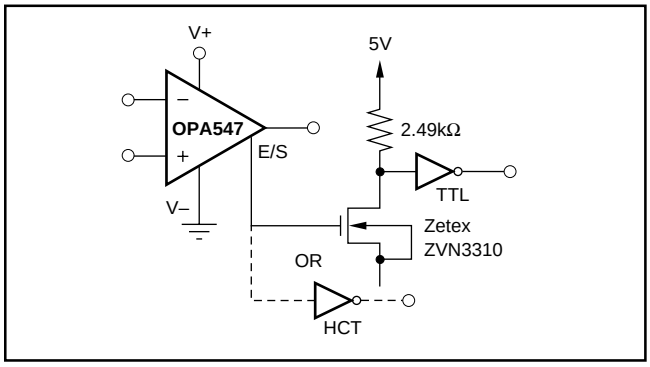


FIGURE 7. Thermal Shutdown Status with a Single Supply.

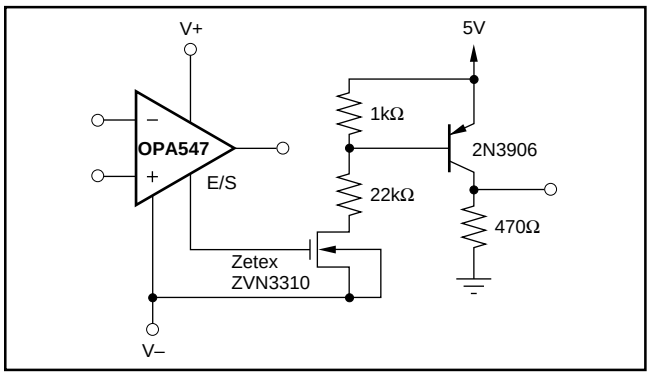


FIGURE 8. Thermal Shutdown Status with Dual Supplies.

Output Disable and Thermal Shutdown Status

As mentioned earlier, the OPA547's output can be disabled and the disable status can be monitored simultaneously. Figures 9 and 10 provide examples using a single supply and dual supplies, respectively.

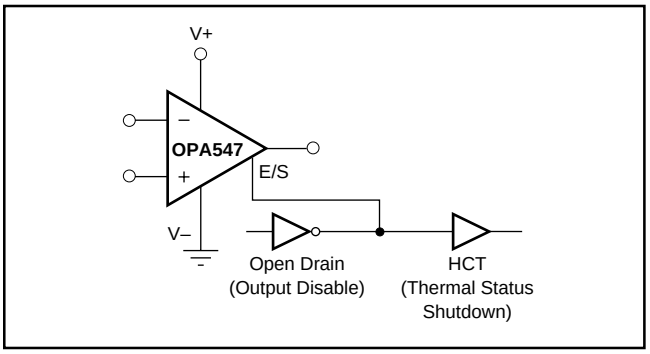


FIGURE 9. Output Disable and Thermal Shutdown Status with a Single Supply.

OUTPUT STAGE COMPENSATION

The complex load impedances common in power op amp applications can cause output stage instability. For normal operation output compensation circuitry is not typically required. However, if the OPA547 is intended to be driven into current limit, a R/C network may be required. Figure 11 shows an output series R/C compensation (snubber) network (3Ω in series with 0.01µF) which generally provides excellent stability. Some variations in circuit values may be required with certain loads.

OUTPUT PROTECTION

Reactive and EMF-generating loads can return load current to the amplifier, causing the output voltage to exceed the power-supply voltage. This damaging condition can be avoided with clamp diodes from the output terminal to the power supplies, as shown in Figure 11. Schottkey rectifier diodes with a 1A or greater continuous rating are recommended.

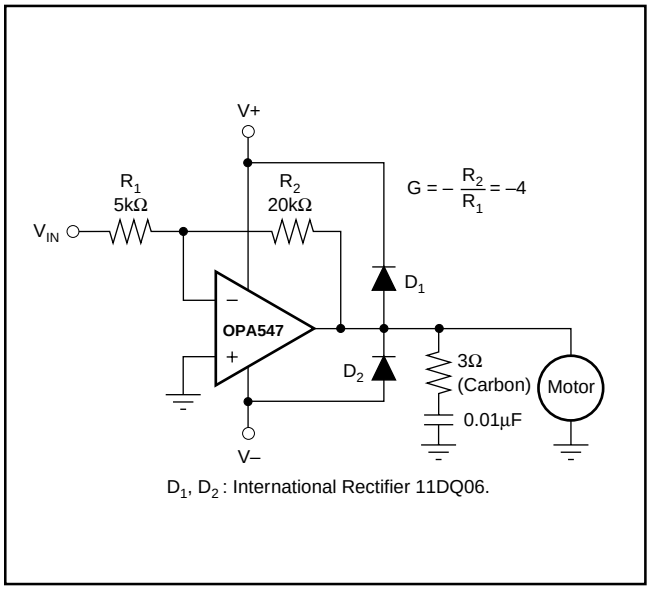


FIGURE 11. Motor Drive Circuit.

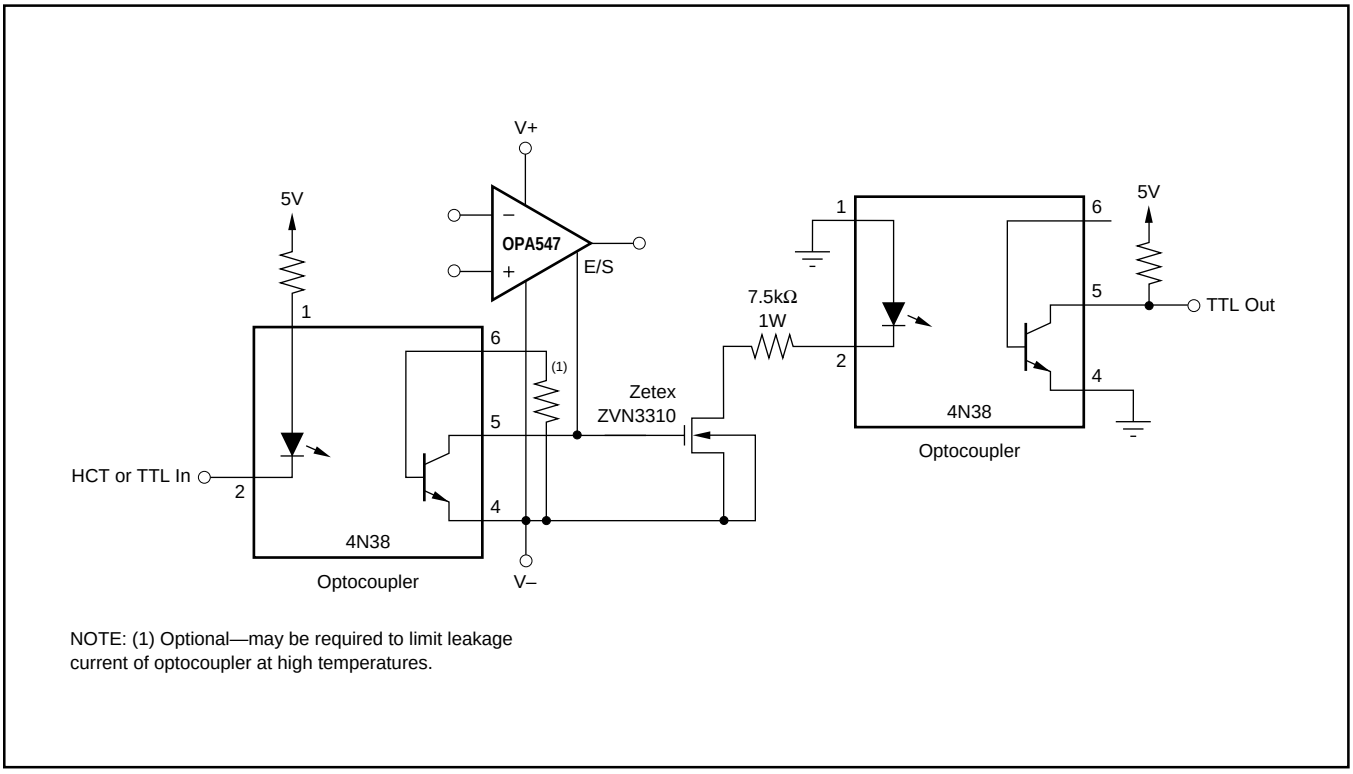


FIGURE 10. Output Disable and Thermal Shutdown Status with Dual Supplies.

VOLTAGE SOURCE APPLICATION

Figure 12 illustrates how to use the OPA547 to provide an accurate voltage source with only three external resistors. First, the current limit resistor, R_{CL}, is chosen according to the desired output current. The resulting voltage at the I_{LIM} pin is constant and stable over temperature. This voltage, V_{CL}, is connected to the noninverting input of the op amp and used as a voltage reference, thus eliminating the need for an external reference. The feedback resistors are selected to gain V_{CL} to the desired output voltage level.

PROGRAMMABLE POWER SUPPLY

A programmable power supply can easily be built using the OPA547. Both the output voltage and output current are user-controlled. Figure 13 shows a circuit using potentiometers to adjust the output voltage and current while Figure 14 uses DACs. An LED tied to the E/S pin through a logic gate indicates if the OPA547 is in thermal shutdown.

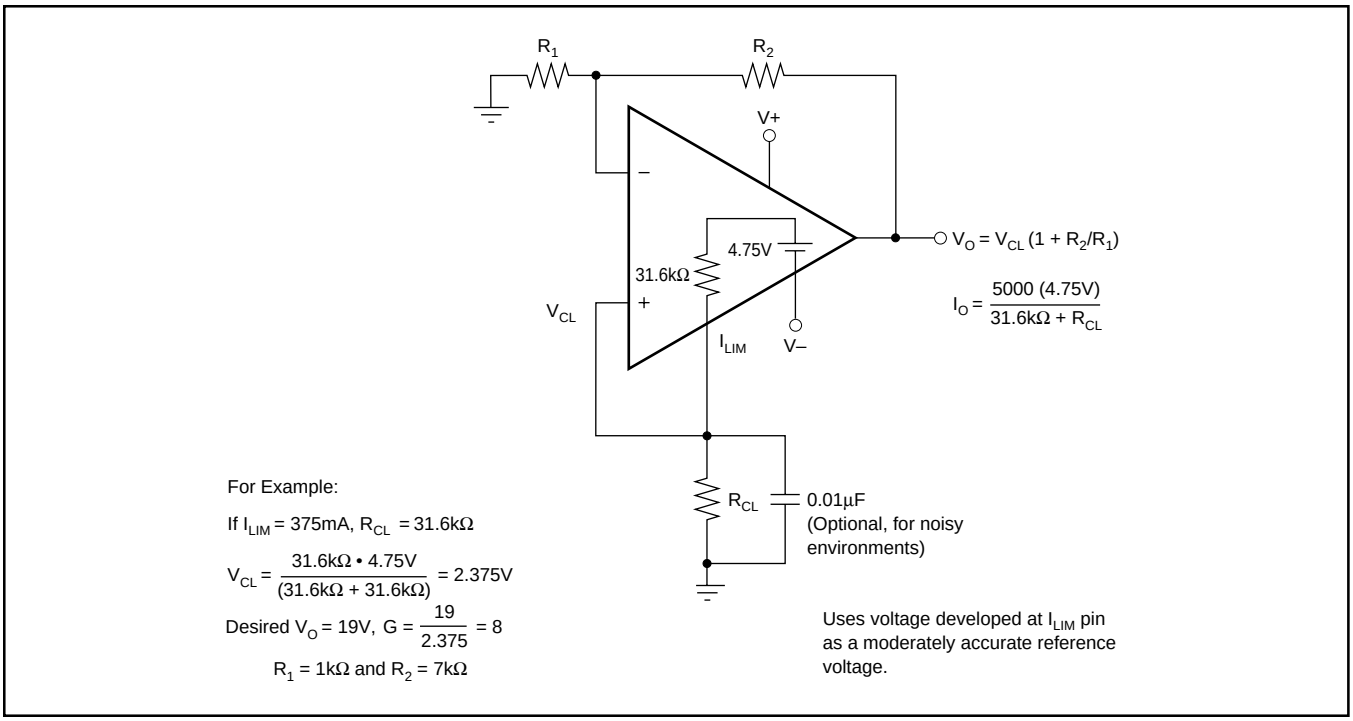


FIGURE 12. Voltage Source.

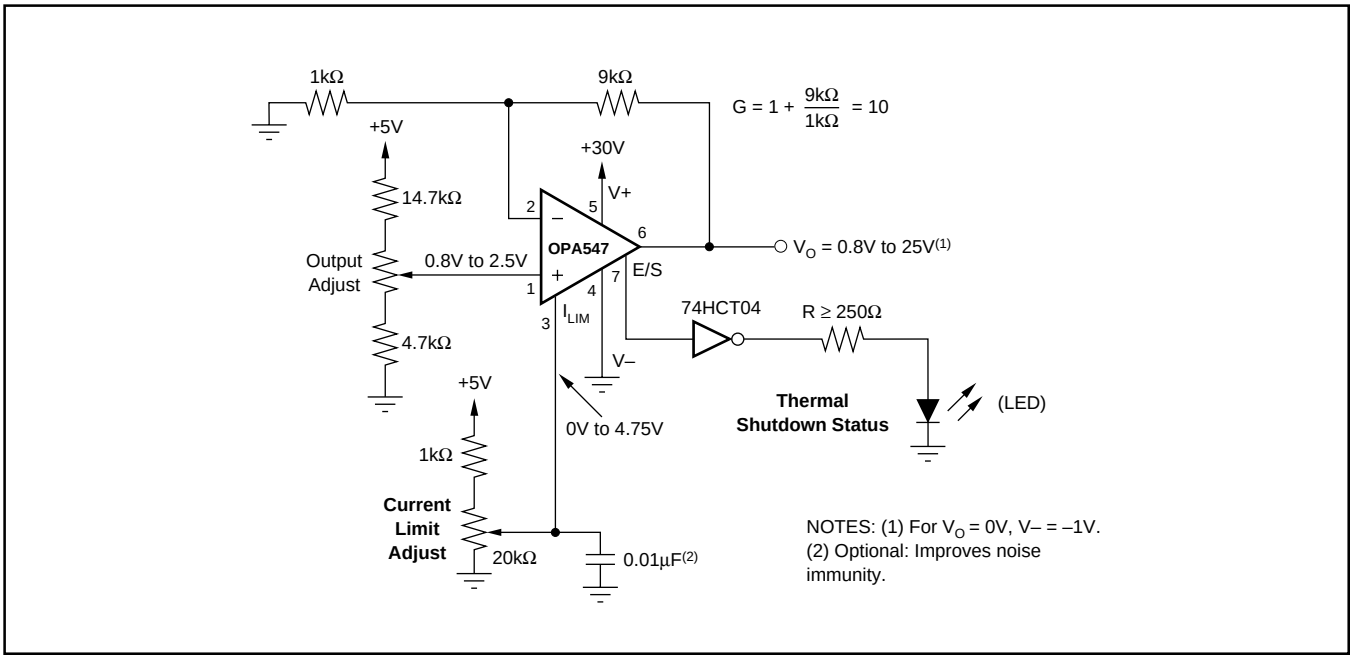
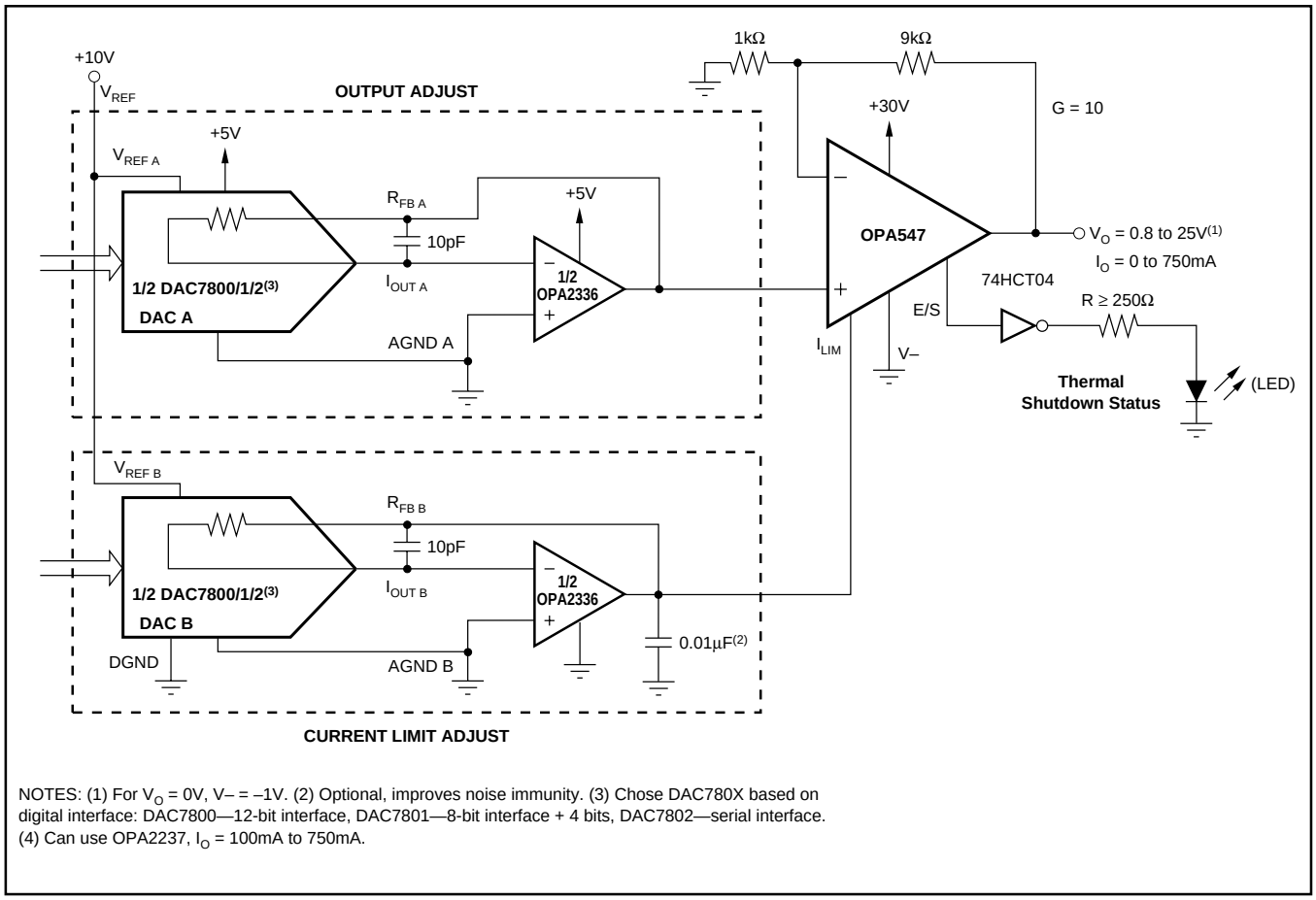
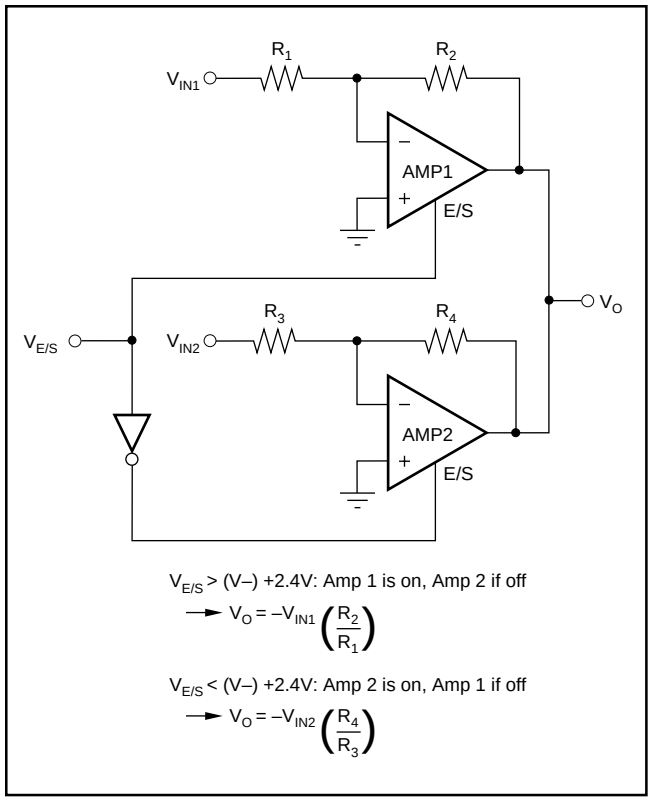


FIGURE 13. Resistor-Controlled Programmable Power Supply.



NOTES: (1) For V_O = 0V, V– = –1V. (2) Optional, improves noise immunity. (3) Chose DAC780X based on digital interface: DAC7800—12-bit interface, DAC7801—8-bit interface + 4 bits, DAC7802—serial interface. (4) Can use OPA2237, I_O = 100mA to 750mA.

FIGURE 14. Digitally-Controlled Programmable Power Supply.



$V_{E/S}$ > (V–) +2.4V: Amp 1 is on, Amp 2 if off

$$\rightarrow V_O = -V_{IN1}\left(\frac{R_2}{R_1}\right)$$

$V_{E/S}$ < (V–) +2.4V: Amp 2 is on, Amp 1 if off

$$\rightarrow V_O = -V_{IN2}\left(\frac{R_4}{R_3}\right)$$

FIGURE 15. Swap Amplifier.

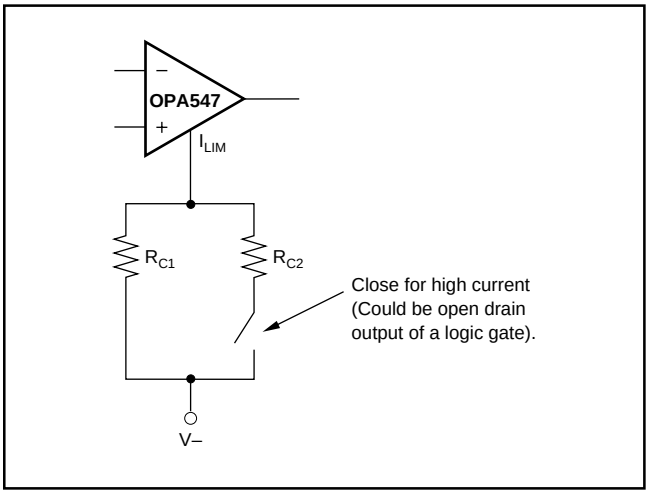


FIGURE 16. Multiple Current Limit Values.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
OPA547F/500	Active	Production	DDPAK/TO-263 (KTW) | 7	500 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	OPA547F
OPA547F/500.A	Active	Production	DDPAK/TO-263 (KTW) | 7	500 | LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	OPA547F
OPA547FKTWT	Active	Production	DDPAK/TO-263 (KTW) | 7	250 | SMALL T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	OPA547F
OPA547FKTWT.A	Active	Production	DDPAK/TO-263 (KTW) | 7	250 | SMALL T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	OPA547F
OPA547T	Active	Production	TO-220 (KVT) | 7	50 | TUBE	Yes	SN	N/A for Pkg Type	-40 to 85	OPA547T
OPA547T-1	Active	Production	TO-220 (KC) | 7	50 | TUBE	Yes	SN	N/A for Pkg Type	-40 to 85	OPA547T
OPA547T-1.A	Active	Production	TO-220 (KC) | 7	50 | TUBE	Yes	SN	N/A for Pkg Type	-40 to 85	OPA547T
OPA547T.A	Active	Production	TO-220 (KVT) | 7	50 | TUBE	Yes	SN	N/A for Pkg Type	-40 to 85	OPA547T
OPA547TG3	Active	Production	TO-220 (KVT) | 7	50 | TUBE	-	Call TI	Call TI	-40 to 85	

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

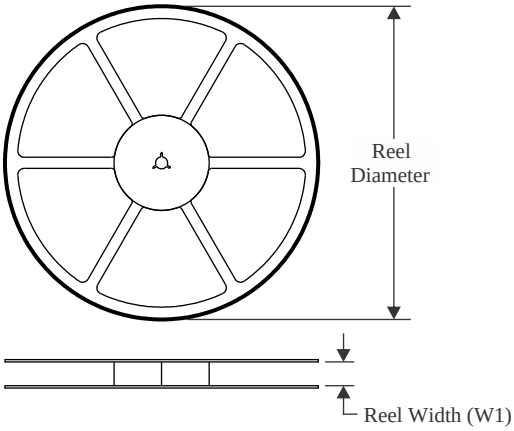
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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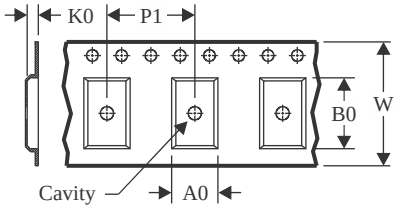
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

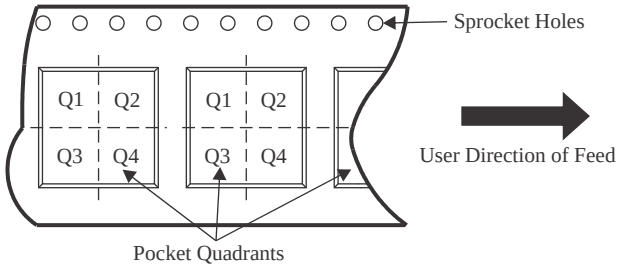


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

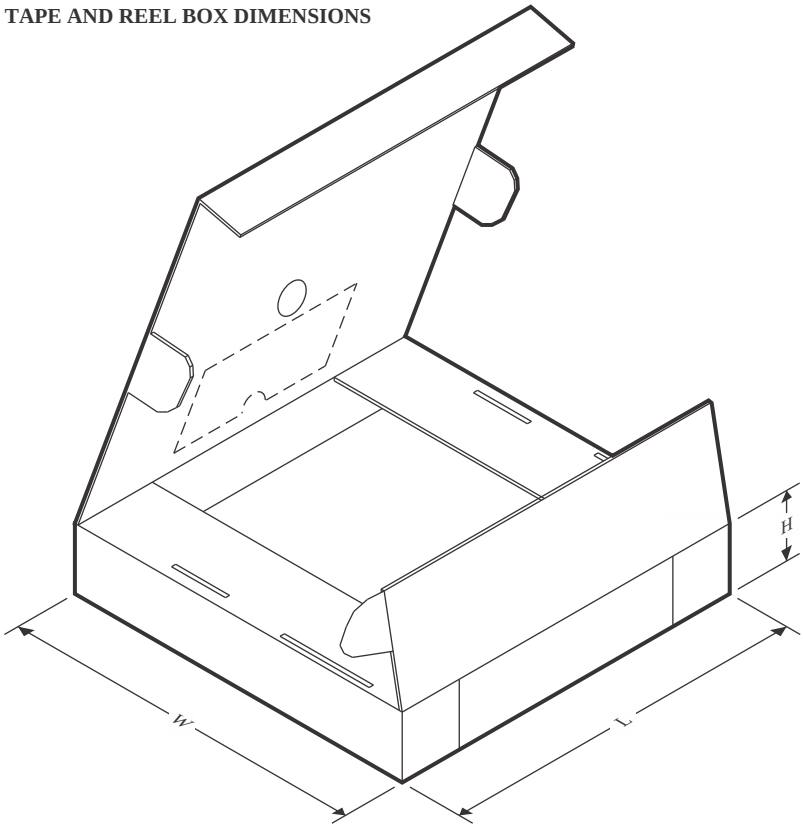
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
OPA547F/500	DDPAK/ TO-263	KTW	7	500	330.0	24.4	10.6	15.8	4.9	16.0	24.0	Q2
OPA547FKTWT	DDPAK/ TO-263	KTW	7	250	330.0	24.4	10.6	15.8	4.9	16.0	24.0	Q2

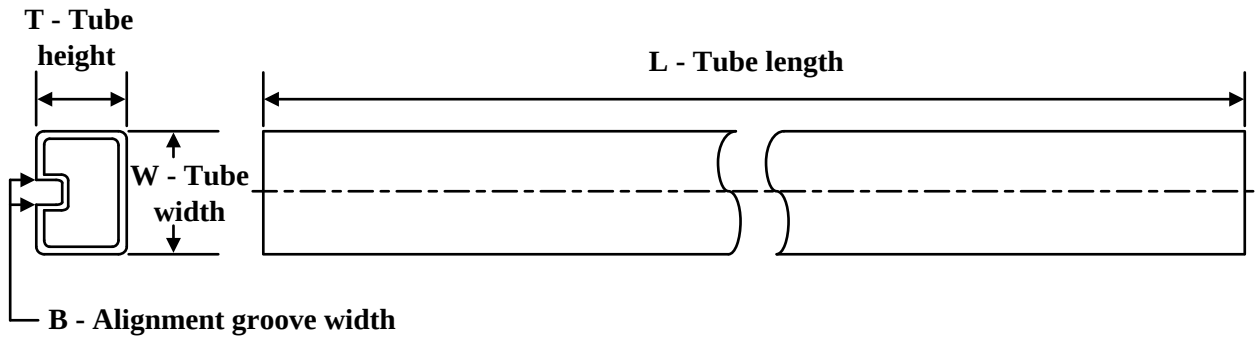
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
OPA547F/500	DDPAK/TO-263	KTW	7	500	356.0	356.0	45.0
OPA547FKTWT	DDPAK/TO-263	KTW	7	250	356.0	356.0	45.0

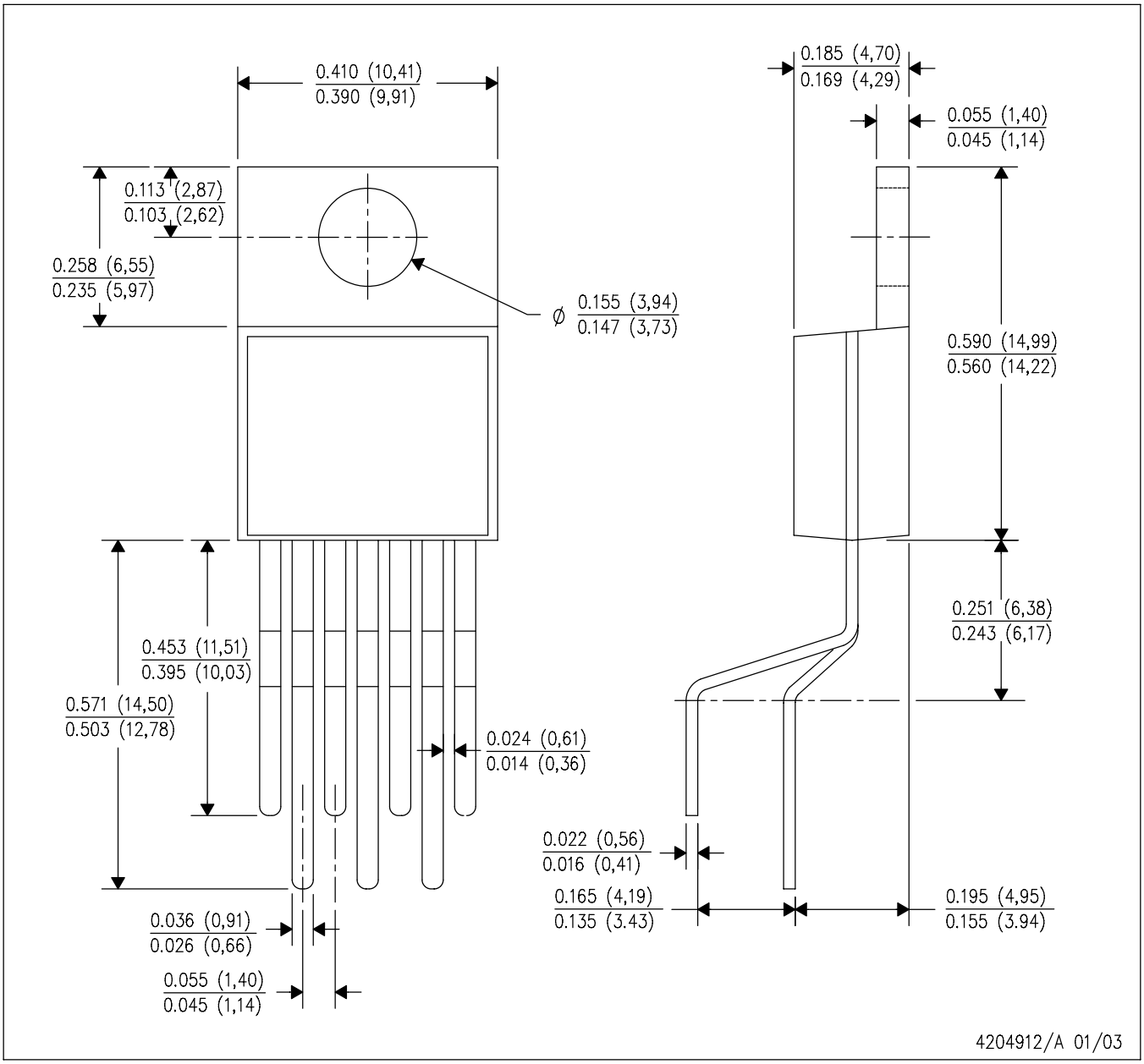
TUBE



*All dimensions are nominal

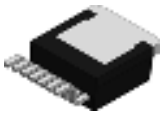
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
OPA547T	KVT	TO-220	7	50	532.13	34.54	13340	NA
OPA547T-1	KC	TO-220	7	50	532.13	34.54	13340	NA
OPA547T-1.A	KC	TO-220	7	50	532.13	34.54	13340	NA
OPA547T.A	KVT	TO-220	7	50	532.13	34.54	13340	NA

KVT (R–PZFM–T7) PLASTIC FLANGE MOUNT PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

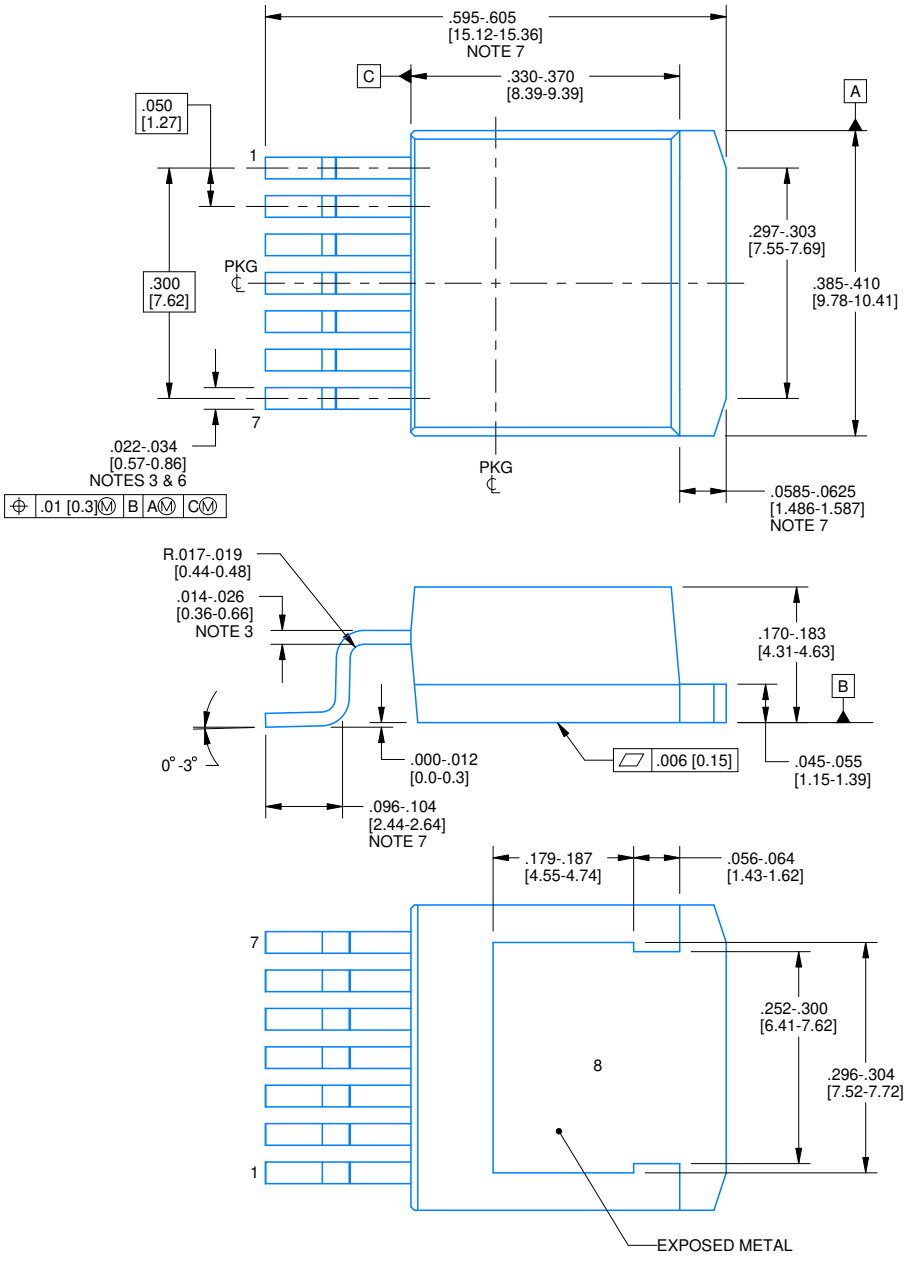
KTW0007A



PACKAGE OUTLINE

TO-263 - 5 mm max height

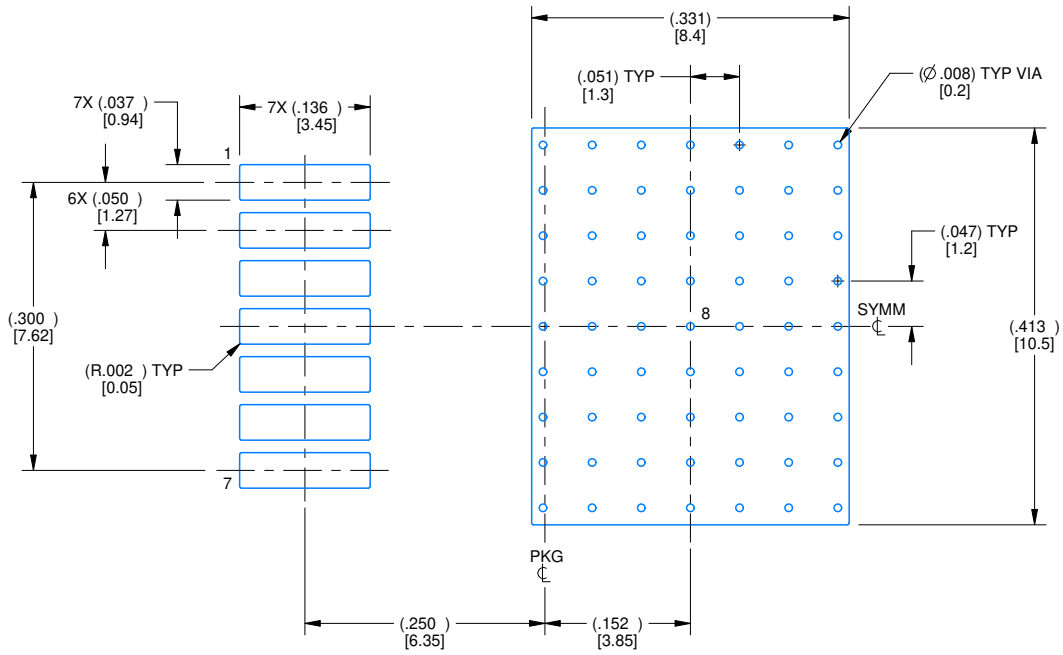
TRANSISTOR OUTLINE



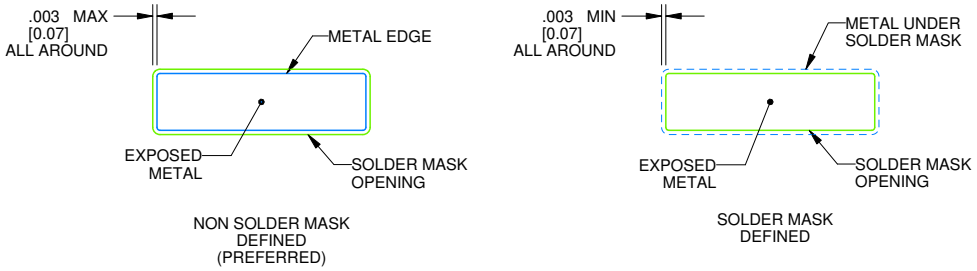
4232469/A 11/2025

NOTES:

1. All linear dimensions are in inches [millimeters]. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Lead width and height dimensions apply to the plated lead.
4. Leads are not allowed above the Datum B.
5. Stand–off height is measured from lead tip with reference to Datum B.
6. Lead width dimension does not include dambar protrusion. Allowable dambar protrusion shall not cause the lead width to exceed the maximum bdimension by more than 0.003”.
7. Falls within JEDEC MO–169 with the exception of the dimensions indicated.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 5X

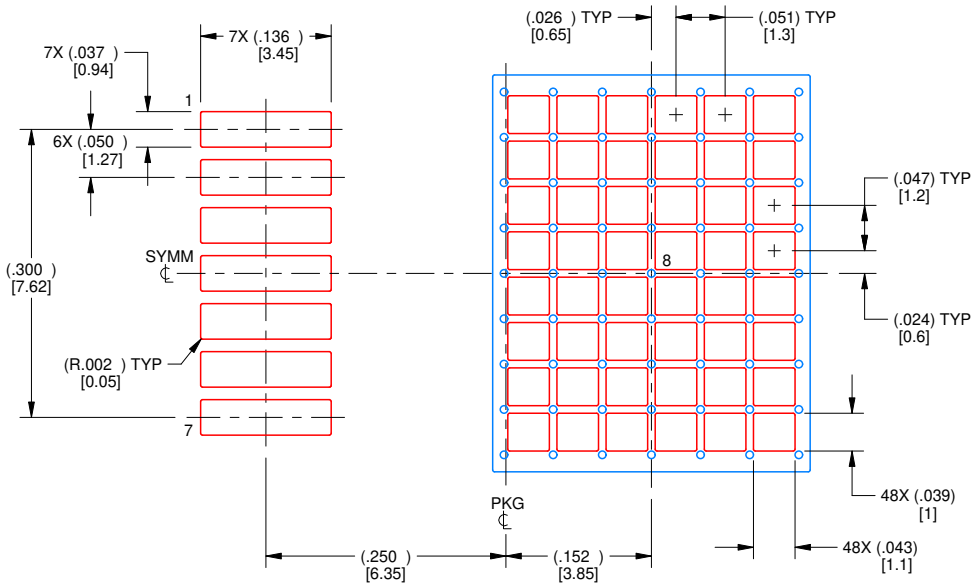


SOLDER MASK DETAILS

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NOTES: (continued)

8. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature numbers SLMA002(www.ti.com/lit/slm002) and SLMA004 (www.ti.com/lit/slma004).
9. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 5X

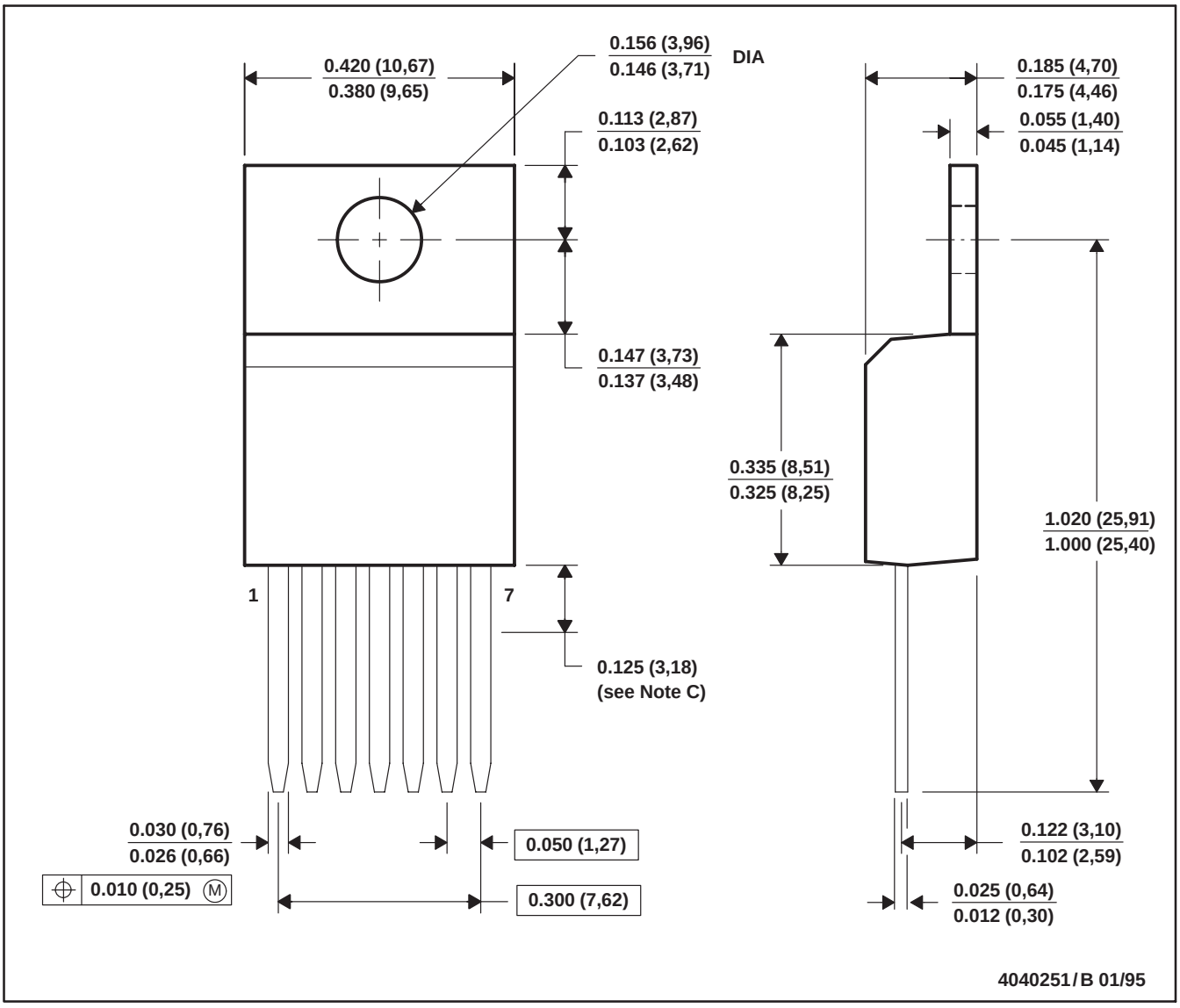
PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
PAD 8: 60%

4232469/A 11/2025

NOTES: (continued)

10. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
11. Board assembly site may have different recommendations for stencil design.

KC (R-PSFM-T7) **PLASTIC FLANGE-MOUNT PACKAGE**



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Lead dimensions are not controlled within this area.
D. All lead dimensions apply before solder dip.
E. The center lead is in electrical contact with the mounting tab.

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